

FEATURES

- Powered from 3.15 V to 26 V
- Precision current sense amplifier
- Precision voltage input
- 12-bit ADC for current and voltage readback
- Convert (CONV) pin for commanding an ADC read
- SETV input for setting overcurrent alert threshold
- ALERTB output provides an overcurrent interrupt
- I²C fast mode-compliant interface (400 kHz maximum)
- 2 address pins allow 16 devices on the same bus
- 10-lead MSOP

APPLICATIONS

- Power monitoring/power budgeting
- Central office equipment
- Telecommunications and data communications equipment
- PCs/servers

GENERAL DESCRIPTION

The ADM1191 is an integrated current sense amplifier that offers digital current and voltage monitoring via an on-chip 12-bit analog-to-digital converter (ADC), communicated through an I²C[®] interface.

An internal current sense amplifier measures voltage across the sense resistor in the power path via the VCC pin and the SENSE pin.

A 12-bit ADC can measure the current seen in the sense resistor, as well as the supply voltage on the VCC pin.

An industry-standard I²C interface allows a controller to read current and voltage data from the ADC. Measurements can be initiated by an I²C command or via the convert (CONV) pin. The CONV pin is especially useful for synchronizing reads on multiple ADM1191 devices. Alternatively, the ADC can run continuously, and the user can read the latest conversion data whenever it is required. Up to 16 unique I²C addresses can be created, depending on the way the A0 pin and the A1 pin are connected.

A SETV pin is also included. A voltage applied to this pin is internally compared with the output voltage on the current sense amplifier. The output of the SETV comparator asserts when the current sense amplifier output exceeds the SETV voltage. When this event occurs, the ALERTB output asserts.

FUNCTIONAL BLOCK DIAGRAM

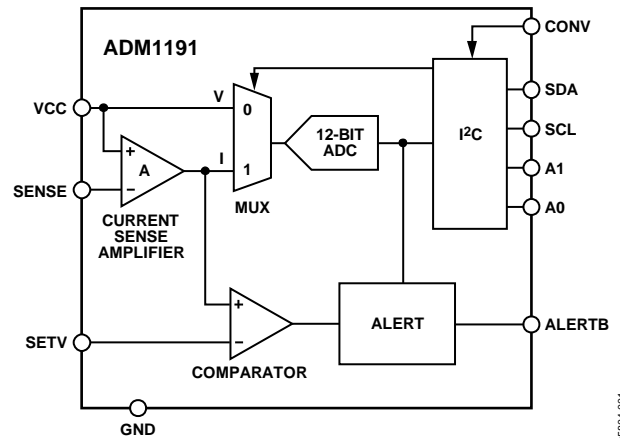


Figure 1.

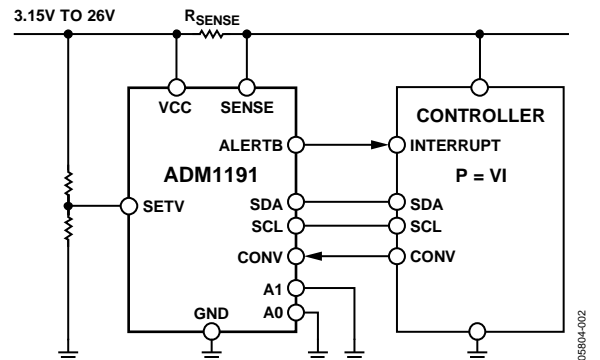


Figure 2. Applications Diagram

The ALERTB output can be used as a flag to warn a microcontroller or field programmable gate array (FPGA) of an overcurrent condition. ALERTB outputs of multiple ADM1191 devices can be tied together and used as a combined alert.

The ADM1191 is packaged in a 10-lead MSOP.

Rev. C

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

TABLE OF CONTENTS

| | | | |
|--|---|--|----|
| Features | 1 | Identifying the ADM1191 on the I ² C Bus..... | 9 |
| Applications..... | 1 | General I ² C Timing..... | 9 |
| General Description | 1 | Write and Read Operations..... | 11 |
| Functional Block Diagram | 1 | Quick Command..... | 11 |
| Revision History | 2 | Write Command Byte | 11 |
| Specifications..... | 3 | Write Extended Command Byte | 12 |
| Absolute Maximum Ratings..... | 5 | Read Voltage and/or Current Data Bytes..... | 13 |
| Thermal Characteristics | 5 | Applications Information | 15 |
| ESD Caution..... | 5 | ALERTB Output | 15 |
| Pin Configuration and Function Descriptions..... | 6 | SETV Pin | 15 |
| Typical Performance Characteristics | 7 | Kelvin Sense Resistor Connection | 15 |
| Voltage and Current Readback | 9 | Outline Dimensions | 16 |
| Serial Bus Interface..... | 9 | Ordering Guide | 16 |

REVISION HISTORY

6/12—Rev. B to Rev. C

| | |
|--|----|
| Added V _{BUS} = 3.0 V to 5.5 V Condition to V _{IL} and V _{IH} , Table 1.. | 4 |
| Changed SETV Pin Rating from 30 V to 6 V, Table 2 | 5 |
| Changes to Pin 3, Pin 5, and Pin 10 Descriptions..... | 6 |
| Changes to Bit 2, Table 9..... | 12 |
| Changes to ALERTB Output Section..... | 15 |
| Changes to Kelvin Sense Resistor Connection Section | 15 |
| Deleted Figure 27..... | 15 |
| Updated Outline Dimensions | 16 |

2/08—Rev. A to Rev. B

| | |
|---|----|
| Changed V _{VCC} to V _{CC} Throughout | 3 |
| Added ADC Conversion Time Parameter | 3 |
| Changes to Input Current for 00 Decode, I _{ADRL} , Parameter ... | 4 |
| Changes to Input Current for 11 Decode, I _{ADR} , Parameter... | 4 |
| Added Endnote 2..... | 4 |
| Changes to Figure 6..... | 7 |
| Changes to Identifying the ADM1191 on the I ² C Bus Section..... | 9 |
| Changes to General I ² C Timing Section, Step 3..... | 9 |
| Changes to Table 5..... | 9 |
| Changes to Figure 16 and Figure 17..... | 10 |
| Changes to Quick Command Section | 11 |
| Changes to Figure 19..... | 11 |
| Changes to Table 7..... | 11 |
| Changes to Write Extended Command Byte Section | 12 |
| Changes to Figure 21 | 12 |
| Changes to Table 9 and Table 11..... | 12 |
| Changes to Converting ADC Codes to Voltage and Current Readings Section..... | 13 |
| Changes to Figure 25..... | 15 |
| Change to SETV Pin Section | 15 |

4/07—Rev. 0 to Rev. A

| | |
|--|----|
| Changes to Table 1..... | 3 |
| Changes to Table 5..... | 9 |
| Changes to Figure 16 and Figure 17 | 10 |
| Changes to Figure 21..... | 12 |
| Changes to Figure 23 and Figure 24 | 13 |
| Added Applications Information Heading | 15 |

9/06—Revision 0: Initial Version

SPECIFICATIONS

$V_{CC} = 3.15\text{ V to }26\text{ V}$, $T_A = -40^\circ\text{C to }+85^\circ\text{C}$, typical values at $T_A = 25^\circ\text{C}$, unless otherwise noted.

Table 1.

| Parameter | Min | Typ | Max | Unit | Conditions |
|--|-------|--------|-------|---------------|--|
| VCC PIN | | | | | |
| Operating Voltage Range, V_{CC} | 3.15 | | 26 | V | VCC rising |
| Supply Current, I_{CC} | | 1.7 | 2 | mA | |
| Undervoltage Lockout, V_{UVLO} | | 2.8 | | V | |
| Undervoltage Lockout Hysteresis, $V_{UVLOHYST}$ | | 80 | | mV | |
| CONV PIN | | | | | |
| Input Current, I_{CONV} | -2 | | +2 | μA | |
| Logic Low Threshold, V_{CONVL} | | | 1.2 | V | |
| Logic High Threshold, V_{CONVH} | 1.4 | | | V | |
| MONITORING ACCURACY¹ | | | | | |
| Current Sense Absolute Accuracy | | | | | |
| 0°C to +70°C | -1.45 | | +1.45 | % | $V_{SENSE} = 75\text{ mV}$ |
| | -1.8 | | +1.8 | % | $V_{SENSE} = 50\text{ mV}$ |
| | -2.8 | | +2.8 | % | $V_{SENSE} = 25\text{ mV}$ |
| | -5.7 | | +5.7 | % | $V_{SENSE} = 12.5\text{ mV}$ |
| 0°C to +85°C | -1.5 | | +1.5 | % | $V_{SENSE} = 75\text{ mV}$ |
| | -1.8 | | +1.8 | % | $V_{SENSE} = 50\text{ mV}$ |
| | -2.95 | | +2.95 | % | $V_{SENSE} = 25\text{ mV}$ |
| | -6.1 | | +6.1 | % | $V_{SENSE} = 12.5\text{ mV}$ |
| -40°C to +85°C | -1.95 | | +1.95 | % | $V_{SENSE} = 75\text{ mV}$ |
| | -2.45 | | +2.45 | % | $V_{SENSE} = 50\text{ mV}$ |
| | -3.85 | | +3.85 | % | $V_{SENSE} = 25\text{ mV}$ |
| | -6.7 | | +6.7 | % | $V_{SENSE} = 12.5\text{ mV}$ |
| V_{SENSE} for ADC Full Scale ² | | 105.84 | | mV | |
| Voltage Sense Accuracy | | | | | |
| 0°C to +70°C | -0.85 | | +0.85 | % | $V_{CC} = 3.0\text{ V to }5.5\text{ V (low range)}$ |
| | -0.9 | | +0.9 | % | $V_{CC} = 10.8\text{ V to }16.5\text{ V (high range)}$ |
| 0°C to +85°C | -0.85 | | +0.85 | % | $V_{CC} = 3.0\text{ V to }5.5\text{ V (low range)}$ |
| | -0.9 | | +0.9 | % | $V_{CC} = 10.8\text{ V to }16.5\text{ V (high range)}$ |
| -40°C to +85°C | -0.9 | | +0.9 | % | $V_{CC} = 3.0\text{ V to }5.5\text{ V (low range)}$ |
| | -1.15 | | +1.15 | % | $V_{CC} = 10.8\text{ V to }16.5\text{ V (high range)}$ |
| V_{CC} for ADC Full Scale ³ | | | | | |
| Low Range (VRANGE = 1) | | 6.65 | | V | |
| High Range (VRANGE = 0) | | 26.52 | | V | |
| ADC Conversion Time ⁴ | | | | | |
| | | 150 | | μs | |
| SENSE PIN | | | | | |
| Input Current, I_{SENSE} | -1 | | +1 | μA | $V_{SENSE} = V_{CC}$ |
| SETV PIN | | | | | |
| Overcurrent Trip Threshold | | | | | |
| | 98 | 100 | 102 | mV | $V_{SETV} = 1.8\text{ V}$ |
| | 49.5 | 50 | 50.5 | mV | $V_{SETV} = 0.9\text{ V}$ |
| Overcurrent Trip Gain, $V_{SETV}/(V_{CC} - V_{SENSE})$ | | | | | |
| | | 18 | | | $V_{SETV} = 0.9\text{ V to }1.9\text{ V}$ |
| Input Current, $I_{SETVLEAK}$ | -1 | | +1 | μA | $V_{SETV} = 0.9\text{ V to }1.9\text{ V}$ |
| ALERTB PIN | | | | | |
| Output Low Voltage, $V_{ALERTOL}$ | | | | | |
| | | 0.05 | 0.1 | V | $I_{ALERT} = -100\text{ }\mu\text{A}$ |
| | | 1 | 1.5 | mA | $I_{ALERT} = -2\text{ mA}$ |
| Input Current, I_{ALERT} | -1 | | +1 | μA | $V_{ALERT} = V_{CC}$; ALERTB not asserted |

| Parameter | Min | Typ | Max | Unit | Conditions |
|---|--------------------|-----|---------------|------------|--|
| A0 PIN, A1 PIN | | | | | |
| Set Address to 00, $V_{ADRLOWV}$ | 0 | | 0.8 | V | Low state |
| Set Address to 01, $R_{ADRLOWZ}$ | 80 | 120 | 160 | k Ω | Resistor to ground state, load pin with specified resistance for 01 decode |
| Set Address to 10, $I_{ADRHIGHZ}$ | -0.3 | | +0.3 | μ A | Open state, maximum load allowed on the A0 pin or A1 pin for 10 decode |
| Set Address to 11, $V_{ADRHIGHV}$ | 2 | | 5.5 | V | High state |
| Input Current for 00 Decode, I_{ADRLOW} | -40 | -25 | | μ A | $V_{ADR} = 0V$ to 0.8 V |
| Input Current for 11 Decode, $I_{ADRHIGH}$ | | 3 | 6 | μ A | $V_{ADR} = 2.0V$ to 5.5 V |
| I ² C TIMING | | | | | |
| Low Level Input Voltage, V_{IL} | | | 0.3 V_{BUS} | V | $V_{BUS} = 3.0V$ to 5.5 V |
| High Level Input Voltage, V_{IH} | 0.7 V_{BUS} | | | V | $V_{BUS} = 3.0V$ to 5.5 V |
| Low Level Output Voltage on SDA, V_{OL} | | | 0.4 | V | $I_{OL} = 3$ mA |
| Output Fall Time on SDA from V_{IHMIN} to V_{ILMAX} | 20 + 0.1 C_{BUS} | | 250 | ns | C_{BUS} = bus capacitance from SDA to GND |
| Maximum Width of Spikes Suppressed by Input Filtering on SDA and SCL Pins | 50 | | 250 | ns | |
| Input Current, I_I , on SDA/SCL When Not Driving a Logic Low Output | -10 | | +10 | μ A | |
| Input Capacitance on SDA/SCL | | 5 | | pF | |
| SCL Clock Frequency, f_{SCL} | | | 400 | kHz | |
| Low Period of the SCL Clock | 600 | | | ns | |
| High Period of the SCL Clock | 1300 | | | ns | |
| Setup Time for Repeated Start Condition, $t_{SU,STA}$ | 600 | | | ns | |
| SDA Output Data Hold Time, $t_{HD,DAT}$ | 100 | | 900 | ns | |
| Setup Time for a Stop Condition, $t_{SU,STO}$ | 600 | | | ns | |
| Bus Free Time Between a Stop and a Start Condition, t_{BUF} | 1300 | | | ns | |
| Capacitive Load for Each Bus Line | | | 400 | pF | |

¹ Monitoring accuracy is a measure of the error in a code that is read back for a particular voltage/current. This is a combination of amplifier error, reference error, ADC error, and error in ADC full-scale code conversion factor.

² This is an absolute value to be used when converting ADC codes to current readings; any inaccuracy in this value is factored into absolute current accuracy values (see the specifications for the Current Sense Absolute Accuracy parameter).

³ These are absolute values to be used when converting ADC codes to voltage readings; any inaccuracy in these values is factored into voltage accuracy values (see the specifications for the Voltage Sense Accuracy parameter).

⁴ Time between the receipt of the command byte and the actual ADC result being placed in the register.

ABSOLUTE MAXIMUM RATINGS

Table 2.

| Parameter | Rating |
|--------------------------------------|-----------------|
| VCC Pin | 30 V |
| SENSE Pin | 30 V |
| CONV Pin | -0.3 V to +6 V |
| SETV Pin | 6 V |
| ALERTB Pin | 30 V |
| SDA Pin, SCL Pin | -0.3 V to +6 V |
| A0 Pin, A1 Pin | -0.3 V to +6 V |
| Storage Temperature Range | -65°C to +125°C |
| Operating Temperature Range | -40°C to +85°C |
| Lead Temperature (Soldering, 10 sec) | 300°C |
| Junction Temperature | 150°C |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

THERMAL CHARACTERISTICS

θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 3. Thermal Resistance

| Package Type | θ_{JA} | Unit |
|--------------|---------------|------|
| 10-Lead MSOP | 137.5 | °C/W |

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

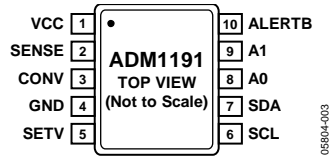


Figure 3. Pin Configuration

Table 4. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
|---------|----------|--|
| 1 | VCC | Positive Supply Input Pin. The operating supply voltage range is from 3.15 V to 26 V. An undervoltage lockout (UVLO) circuit resets the ADM1191 when a low supply voltage is detected. |
| 2 | SENSE | Current Sense Input Pin. A sense resistor between the VCC pin and the SENSE pin generates a voltage across a sense resistor. This voltage is proportional to the load current. A current sense amplifier amplifies this voltage before it is digitized by the ADC. |
| 3 | CONV | Convert Start Pin. A high level on this pin enables an ADC conversion. The state of an internal control register, which is set through the I ² C interface, configures the part to convert current only, voltage only, or both channels when the convert pin is asserted. If not required, this pin should be tied high to allow ADC to run. |
| 4 | GND | Chip Ground Pin. |
| 5 | SETV | Input Pin. The voltage driven onto this pin is compared with the output of the internal current sense amplifier. The lower the voltage on the SETV, the lower the current level that causes the ALERTB output to assert. Typical response time is 1 μ s to 2 μ s. |
| 6 | SCL | I ² C Clock Pin. Open-drain input; requires an external resistive pull-up. |
| 7 | SDA | I ² C Data I/O Pin. Open-drain input/output; requires an external resistive pull-up. |
| 8 | A0 | I ² C Address Pin. This pin can be tied low, tied high, left floating, or tied low through a resistor. Sixteen I ² C address options are available, depending on the external configuration of the A0 pin and the A1 pin. |
| 9 | A1 | I ² C Address Pin. This pin can be tied low, tied high, left floating, or tied low through a resistor. Sixteen I ² C address options are available, depending on the external configuration of the A0 pin and the A1 pin. |
| 10 | ALERTB | Alert Output Pin. Active low, open-drain configuration. This pin asserts low when an overcurrent condition is present. The level at which an overcurrent condition is detected depends on either the voltage on the SETV pin or the value in the ALERT_TH register. The ALERT_EN register will determine which is used in the comparison. This pin has a latching function and should be cleared manually using the ALERT_EN register. |

TYPICAL PERFORMANCE CHARACTERISTICS

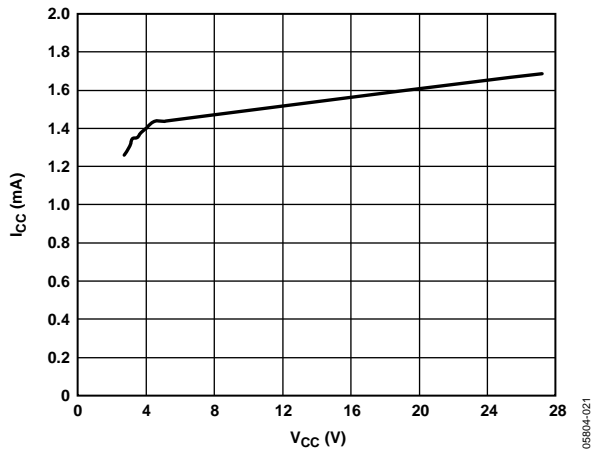


Figure 4. Supply Current vs. Supply Voltage

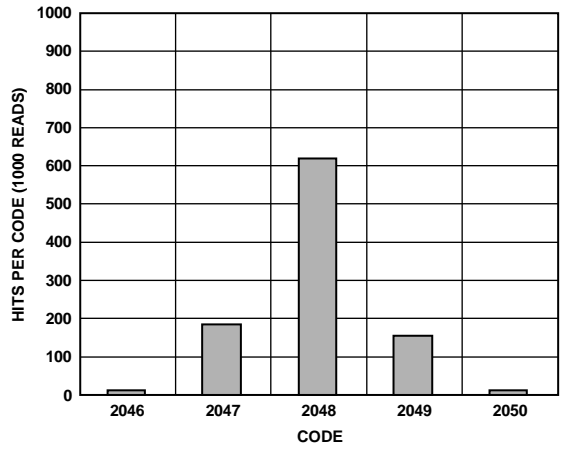


Figure 7. ADC Noise with Current Channel, Midcode Input, and 1000 Reads

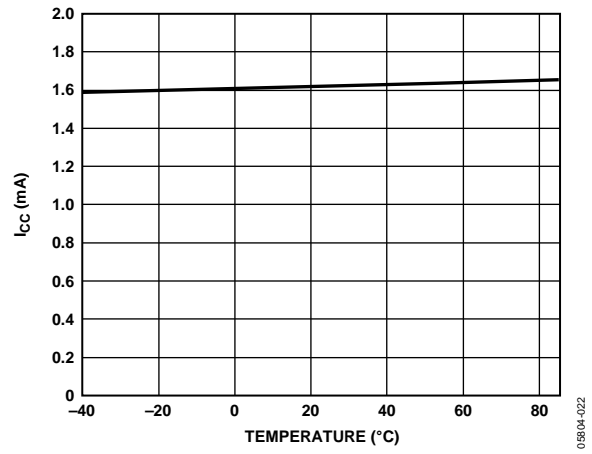


Figure 5. Supply Current vs. Temperature

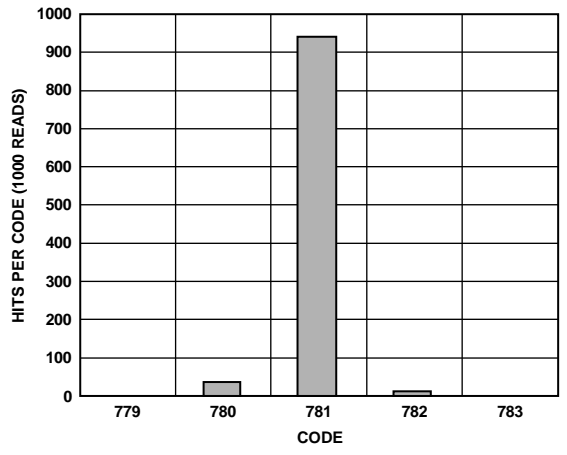


Figure 8. ADC Noise with 14:1 Voltage Channel, 5 V Input, and 1000 Reads

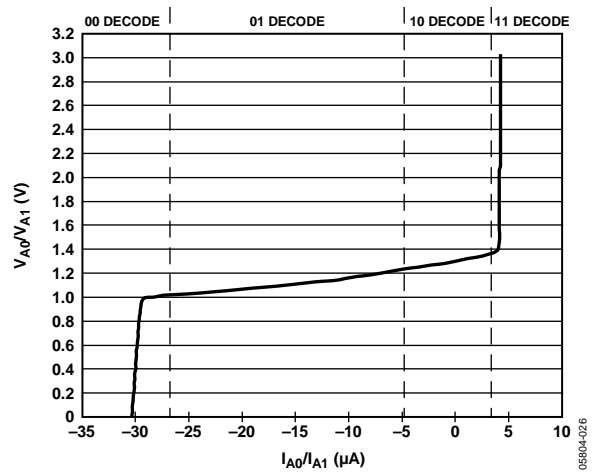


Figure 6. Address Pin Voltage vs. Address Pin Current for Four Addressing Options on Each Address Pin

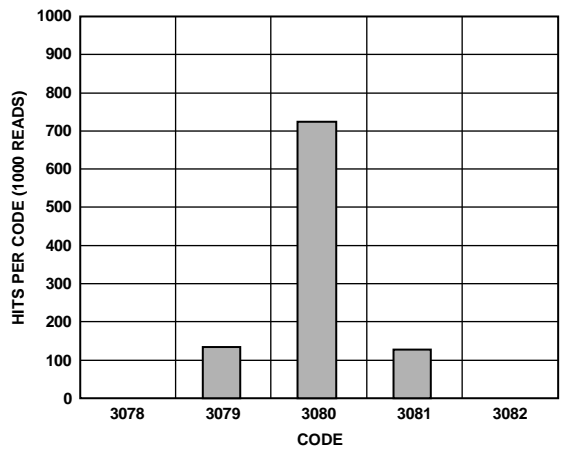


Figure 9. ADC Noise with 7:1 Voltage Channel, 5 V Input, and 1000 Reads

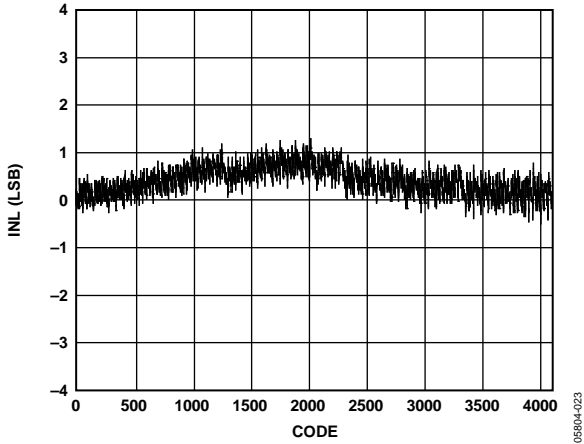


Figure 10. INL for ADC

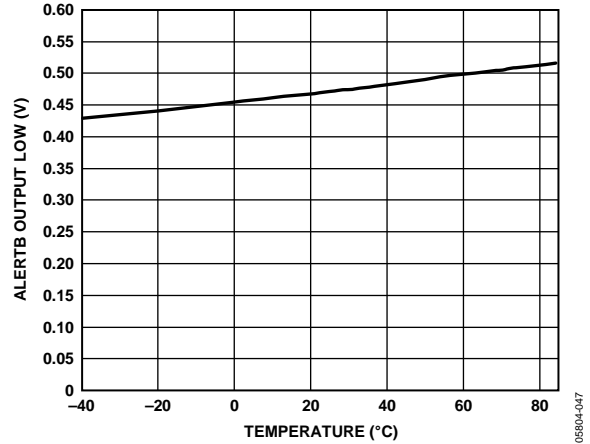


Figure 13. ALERTB Output Low Voltage vs. Temperature @ 1 mA

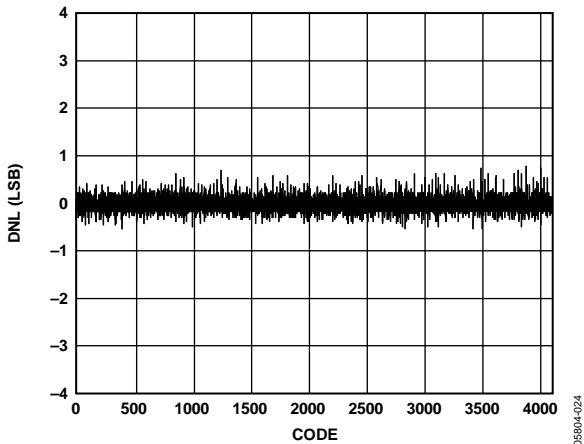


Figure 11. DNL for ADC

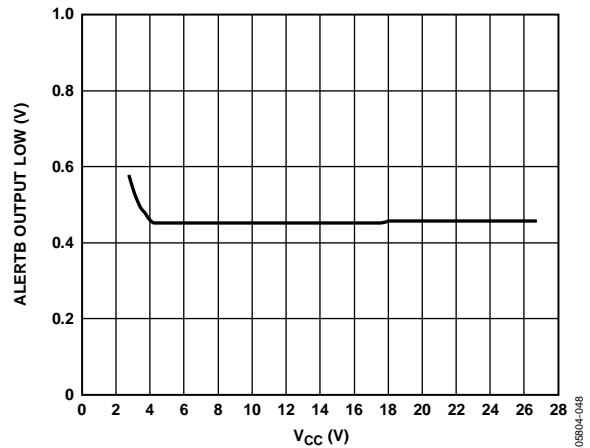


Figure 14. ALERTB Output Low Voltage vs. Supply Voltage @ 1 mA

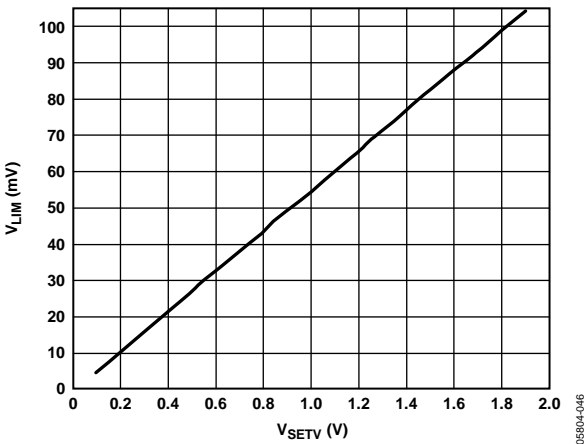


Figure 12. Overcurrent Limit Threshold vs. SETV Pin Voltage

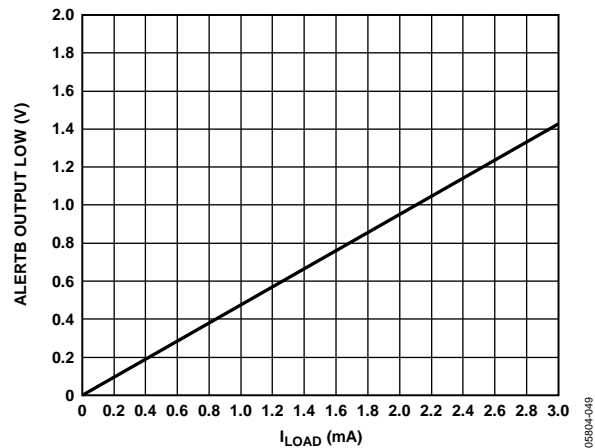


Figure 15. ALERTB Output Low Voltage vs. Load Current

VOLTAGE AND CURRENT READBACK

The ADM1191 contains the components to allow voltage and current readback over an I²C bus. The voltage output of the current sense amplifier and the voltage on the VCC pin are fed into a 12-bit ADC via a multiplexer. The device can be instructed to convert voltage and/or current at any time during operation by issuing an I²C command or driving the CONV pin high. When all conversions are complete, the voltage and/or current values can be read back with 12-bit accuracy in two or three bytes.

SERIAL BUS INTERFACE

Control of the ADM1191 is carried out via the serial system management bus (I²C). This interface is compatible with the I²C fast mode (400 kHz maximum). The ADM1191 is connected to this bus as a slave device, under the control of a master device.

IDENTIFYING THE ADM1191 ON THE I²C BUS

The ADM1191 has a 7-bit serial bus slave address. When the device powers up, it does so with a default serial bus address. The three MSBs of the address are set to 011; the four LSBs are determined by the state of the A0 pin and the A1 pin. There are 16 configurations available on the A0 pin and A1 pin that correspond to 16 I²C addresses for the four LSBs (see Table 5). This scheme allows 16 ADM1191 devices to operate on a single I²C bus.

GENERAL I²C TIMING

Figure 16 and Figure 17 show timing diagrams for general write and read operations using the I²C. The I²C specification defines conditions for different types of read and write operations, which are discussed in the Write and Read Operations section. The general I²C protocol operates as follows:

1. The master initiates a data transfer by establishing a start condition, defined as a high-to-low transition on the serial data line, SDA, while the serial clock line, SCL, remains high. This indicates that a data stream is to follow. All slave peripherals connected to the serial bus respond to the start condition and shift in the next eight bits, consisting of a 7-bit slave address (MSB first) plus an R/W bit that determines the direction of the data transfer, that is, whether data is written to or read from the slave device (0 = write, 1 = read).
2. Data is sent over the serial bus in sequences of nine clock pulses: eight bits of data followed by an acknowledge bit from the slave device. Data transitions on the data line must occur during the low period of the clock signal and remain stable during the high period because a low-to-high transition when the clock is high can be interpreted as a stop signal.
3. When all data bytes are read or written, stop conditions are established. In write mode, the master pulls the data line high during the 10th clock pulse to assert a stop condition. In read mode, the master device releases the SDA line during the SCL low period before the ninth clock pulse, but the slave device does not pull it low. This is known as a no acknowledge. The master then takes the data line low during the SCL low period before the 10th clock pulse and then high during the 10th clock pulse to assert a stop condition.

The peripheral whose address corresponds to the transmitted address responds by pulling the data line low during the low period before the ninth clock pulse, known as the acknowledge bit, and holding it low during the high period of this clock pulse. All other devices on the bus remain idle while the selected device waits for data to be read from it or written to it. If the R/W bit is 0, the master writes to the slave device. If the R/W bit is 1, the master reads from the slave device.

Because data can flow in only one direction, as defined by the R/W bit, it is not possible to send a command to a slave device during a read operation. Before performing a read operation, it may be necessary to first execute a write operation to tell the slave what sort of read operation to expect and/or the address from which data is to be read.

Before performing a read operation, it may be necessary to first execute a write operation to tell the slave what sort of read operation to expect and/or the address from which data is to be read.

Because data can flow in only one direction, as defined by the R/W bit, it is not possible to send a command to a slave device during a read operation. Before performing a read operation, it may be necessary to first execute a write operation to tell the slave what sort of read operation to expect and/or the address from which data is to be read.

Table 5. Setting I²C Addresses via the A0 Pin and the A1 Pin

| Base Address | A1 Pin State | A0 Pin State | A1 Pin Logic State | A0 Pin Logic State | Address in Binary ¹ | Address in Hex |
|--------------|--------------------|--------------------|--------------------|--------------------|--------------------------------|----------------|
| 011 | Ground | Ground | 00 | 00 | 0110000X | 0x60 |
| | Ground | Resistor to ground | 00 | 01 | 0110001X | 0x62 |
| | Ground | Floating | 00 | 10 | 0110010X | 0x64 |
| | Ground | High | 00 | 11 | 0110011X | 0x66 |
| | Resistor to ground | Ground | 01 | 00 | 0110100X | 0x68 |
| | Resistor to ground | Resistor to ground | 01 | 01 | 0110101X | 0x6A |
| | Resistor to ground | Floating | 01 | 10 | 0110110X | 0x6C |
| | Resistor to ground | High | 01 | 11 | 0110111X | 0x6E |
| | Floating | Ground | 10 | 00 | 0111000X | 0x70 |
| | Floating | Resistor to ground | 10 | 01 | 0111001X | 0x72 |

| Base Address | A1 Pin State | A0 Pin State | A1 Pin Logic State | A0 Pin Logic State | Address in Binary ¹ | Address in Hex |
|--------------|--------------|--------------------|--------------------|--------------------|--------------------------------|----------------|
| | Floating | Floating | 10 | 10 | 0111010X | 0x74 |
| | Floating | High | 10 | 11 | 0111011X | 0x76 |
| | High | Ground | 11 | 00 | 0111100X | 0x78 |
| | High | Resistor to ground | 11 | 01 | 0111101X | 0x7A |
| | High | Floating | 11 | 10 | 0111110X | 0x7C |
| | High | High | 11 | 11 | 0111111X | 0x7E |

¹X = don't care.

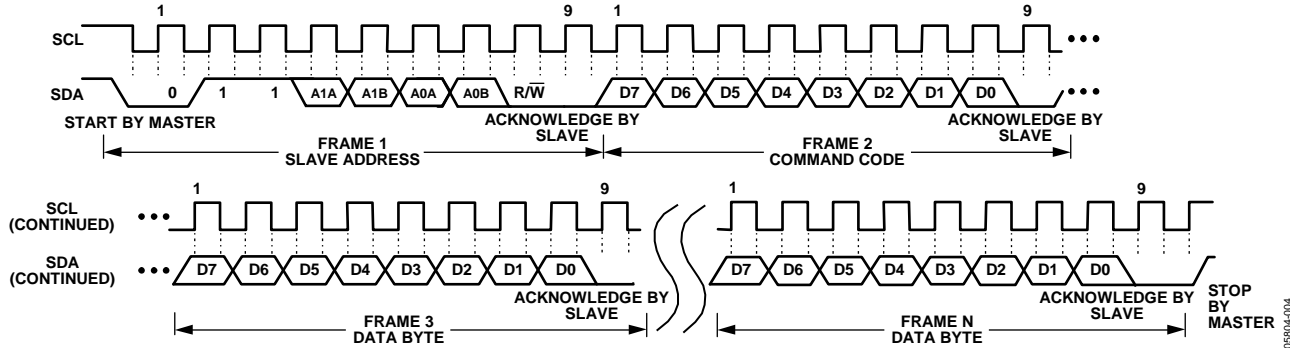


Figure 16. General I2C Write Timing Diagram

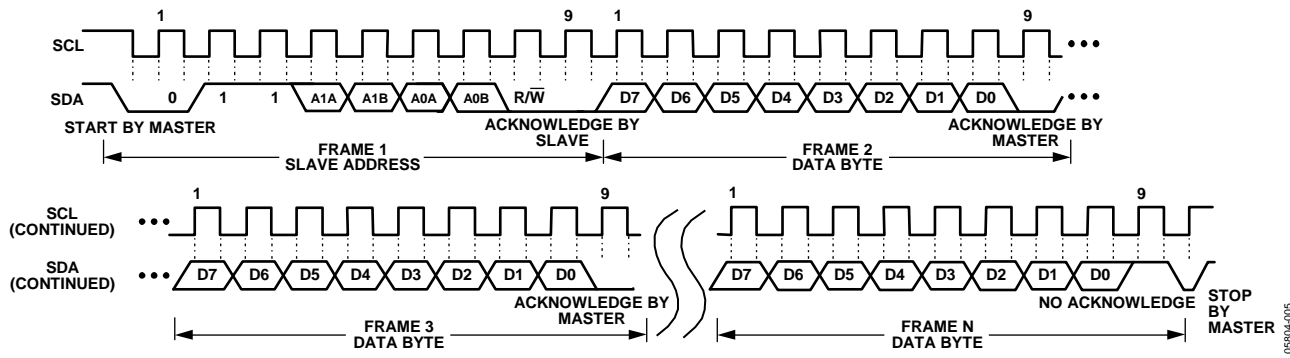


Figure 17. General I2C Read Timing Diagram

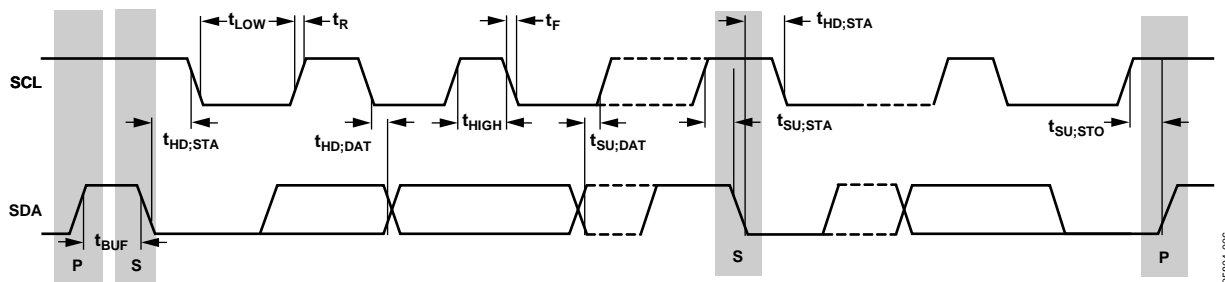


Figure 18. Serial Bus Timing Diagram

WRITE AND READ OPERATIONS

The I²C specification defines several protocols for different types of read and write operations. The operations used in the ADM1191 are discussed in this section. Table 6 shows the abbreviations used in the command diagrams (see Figure 19 to Figure 24).

Table 6. I²C Abbreviations

| Abbreviation | Condition |
|--------------|----------------|
| S | Start |
| P | Stop |
| R | Read |
| W | Write |
| A | Acknowledge |
| N | No acknowledge |

QUICK COMMAND

The quick command operation allows the master to check if the slave is present on the bus, as follows:

1. The master device asserts a start condition on SDA.
2. The master sends the 7-bit slave address, followed by the write bit (low).
3. The addressed slave device asserts an acknowledge on SDA.
4. The master asserts a stop condition on SDA to end the transaction.

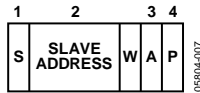


Figure 19. Quick Command

WRITE COMMAND BYTE

In the write command byte operation, the master device sends a command byte to the slave device, as follows:

1. The master device asserts a start condition on SDA.
2. The master sends the 7-bit slave address, followed by the write bit (low).
3. The addressed slave device asserts an acknowledge on SDA.
4. The master sends the command byte. The command byte is identified by an MSB = 0. An MSB = 1 indicates an extended register write (see the Write Extended Command Byte section).
5. The slave asserts an acknowledge on SDA.
6. The master asserts a stop condition on SDA to end the transaction.

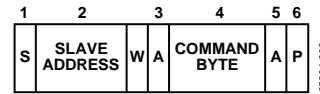


Figure 20. Write Command Byte

The seven LSBs of the command byte are used to configure and control the ADM1191. Table 7 provides details of the function of each bit.

Table 7. Command Byte Operations

| Bit | Default | Name | Function |
|-----|---------|-----------|---|
| C0 | 0 | V_CONT | LSB, set to convert voltage continuously. If readback is attempted before the first conversion is complete, the ADM1191 asserts an acknowledge and returns all 0s in the returned data. |
| C1 | 0 | V_ONCE | Set to convert voltage once. Self-clears. I ² C asserts a no acknowledge on attempted reads until the ADC conversion is complete. |
| C2 | 0 | I_CONT | Set to convert current continuously. If readback is attempted before the first conversion is complete, the ADM1191 asserts an acknowledge and returns all 0s in the returned data. |
| C3 | 0 | I_ONCE | Set to convert current once. Self-clears. I ² C asserts a no acknowledge on attempted reads until the ADC conversion is complete. |
| C4 | 0 | VRANGE | Selects different internal attenuation resistor networks for voltage readback. A 0 in C4 selects a 14:1 voltage divider. A 1 in C4 selects a 7:2 voltage divider. With an ADC full scale of 1.902 V, the voltage at the VCC pin for an ADC full-scale result is 26.52 V for VRANGE = 0 and 6.65 V for VRANGE = 1. |
| C5 | 0 | N/A | Unused. |
| C6 | 0 | STATUS_RD | Status Read. When this bit is set, the data byte read back from the ADM1191 is the status byte. It contains the status of the device alerts. See Table 15 for full details of the status byte. |

WRITE EXTENDED COMMAND BYTE

In the write extended command byte operation, the master device writes to one of the three extended registers of the slave device, as follows:

1. The master device asserts a start condition on SDA.
2. The master sends the 7-bit slave address, followed by the write bit (low).
3. The addressed slave device asserts an acknowledge on SDA.
4. The master sends the register address byte. The MSB of this byte is set to 1 to indicate an extended register write. The two LSBs indicate which of the three extended registers is to be written to (see Table 8). All other bits should be set to 0.
5. The slave asserts an acknowledge on SDA.
6. The master sends the extended command byte (refer to Table 9, Table 10, and Table 11).

7. The slave asserts an acknowledge on SDA.
8. The master asserts a stop condition on SDA to end the transaction.

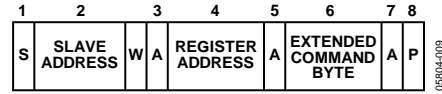


Figure 21. Write Extended Byte

Table 9, Table 10, and Table 11 provide the details of each extended register.

Table 8. Extended Register Addresses

| A6 | A5 | A4 | A3 | A2 | A1 | A0 | Extended Register |
|----|----|----|----|----|----|----|-------------------|
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | ALERT_EN |
| 0 | 0 | 0 | 0 | 0 | 1 | 0 | ALERT_TH |
| 0 | 0 | 0 | 0 | 0 | 1 | 1 | CONTROL |

Table 9. ALERT_EN Register Operations

| Bit | Default | Name | Function |
|-----|---------|--------------|--|
| 0 | 0 | EN_ADC_OC1 | LSB, enabled if a single ADC conversion on the I channel exceeds the threshold set in the ALERT_TH register. |
| 1 | 0 | EN_ADC_OC4 | Enabled if four consecutive ADC conversions on the I channel exceed the threshold set in the ALERT_TH register. |
| 2 | 0 | EN_OC_ALERT | Enables the OC_ALERT register. If an overcurrent condition is present compared to the SETV threshold, the OC_ALERT register captures and latches this condition. |
| 3 | 0 | EN_OFF_ALERT | Set this bit high to activate the SWOFF bit (see Table 11). |
| 4 | 0 | CLEAR | Clears the OFF_ALERT, OC_ALERT, and ADC_ALERT status bits in the status register. The value of these bits may immediately change if the source of the alert is not been cleared and the alert function is not disabled. The CLEAR bit self-clears to 0 after the STATUS register bits have been cleared. |

Table 10. ALERT_TH Register Operations

| Bit | Default | Function |
|-----|---------|--|
| 7:0 | FF | The ALERT_TH register sets the current level at which an alert occurs. Defaults to ADC full scale. The ALERT_TH 8-bit value corresponds to the top eight bits of the current channel data. |

Table 11. CONTROL Register Operations

| Bit | Default | Name | Function |
|-----|---------|-------|---|
| 0 | 0 | SWOFF | LSB, forces the ALERTB pin to deassert. Can be active only if the EN_OFF_ALERT bit is high (see Table 9). |

READ VOLTAGE AND/OR CURRENT DATA BYTES

Depending on how the device is configured, ADM1191 can be set up to provide information in three ways after a conversion (or conversions): voltage and current readback, voltage only readback, and current only readback. See the Write Command Byte section for more details.

Voltage and Current Readback

The ADM1191 digitizes both voltage and current. Three bytes are read back in the format shown in Table 12.

Table 12. Voltage and Current Readback

| Byte | Contents | B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 |
|------|--------------|-----|-----|----|----|----|----|----|----|
| 1 | Voltage MSBs | V11 | V10 | V9 | V8 | V7 | V6 | V5 | V4 |
| 2 | Current MSBs | I11 | I10 | I9 | I8 | I7 | I6 | I5 | I4 |
| 3 | LSBs | V3 | V2 | V1 | V0 | I3 | I2 | I1 | I0 |

Voltage Readback

The ADM1191 digitizes voltage only. Two bytes are read back in the format shown in Table 13.

Table 13. Voltage Only Readback Format

| Byte | Contents | B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 |
|------|--------------|-----|-----|----|----|----|----|----|----|
| 1 | Voltage MSBs | V11 | V10 | V9 | V8 | V7 | V6 | V5 | V4 |
| 2 | Voltage LSBs | V3 | V2 | V1 | V0 | 0 | 0 | 0 | 0 |

Current Readback

The ADM1191 digitizes current only. Two bytes are read back in the format shown in Table 14.

Table 14. Current Only Readback Format

| Byte | Contents | B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 |
|------|--------------|-----|-----|----|----|----|----|----|----|
| 1 | Current MSBs | I11 | I10 | I9 | I8 | I7 | I6 | I5 | I4 |
| 2 | Current LSBs | I3 | I2 | I1 | I0 | 0 | 0 | 0 | 0 |

The following series of events occurs when the master receives three bytes (voltage and current data) from the slave device:

1. The master device asserts a start condition on SDA.
2. The master sends the 7-bit slave address, followed by the read bit (high).
3. The addressed slave device asserts an acknowledge on SDA.
4. The master receives the first data byte.
5. The master asserts an acknowledge on SDA.
6. The master receives the second data byte.
7. The master asserts an acknowledge on SDA.
8. The master receives the third data byte.

9. The master asserts a no acknowledge on SDA.
10. The master asserts a stop condition on SDA, and the transaction ends.

For cases where the master is reading voltage only or current only, two data bytes are read and Step 7 and Step 8 are not required.

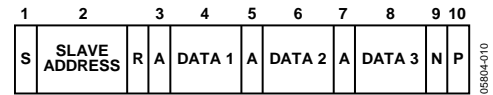


Figure 22. Three-Byte Read from ADM1191

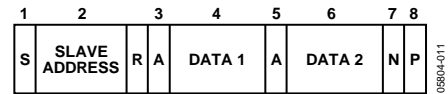


Figure 23. Two-Byte Read from ADM1191

Converting ADC Codes to Voltage and Current Readings

Equation 1 and Equation 2 can be used to convert ADC codes representing voltage and current from the ADM1191 12-bit ADC into actual voltage and current values.

$$Voltage = (V_{FULLSCALE}/4096) \times Code \tag{1}$$

where:

$$V_{FULLSCALE} = 6.65 \text{ V (7:2 range) or } 26.52 \text{ V (14:1 range).}$$

Code is the ADC voltage code read from the device (Bit V11 to Bit V0).

$$Current = ((I_{FULLSCALE}/4096) \times Code)/Sense \text{ Resistor} \tag{2}$$

where:

$$I_{FULLSCALE} = 105.84 \text{ mV.}$$

Code is the ADC current code read from the device (Bit I11 to Bit I0).

Read Status Register

A single register of status data can also be read from the ADM1191 as follows:

1. The master device asserts a start condition on SDA.
2. The master sends the 7-bit slave address, followed by the read bit (high).
3. The addressed slave device asserts an acknowledge on SDA.
4. The master receives the status byte.
5. The master asserts an acknowledge on SDA.

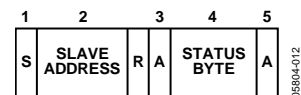


Figure 24. Status Read from ADM1191

Table 15 shows the ADM1191 STATUS registers in detail. Note that Bit 1, Bit 3, and Bit 5 are cleared by writing to Bit 4 (the CLEAR bit) of the ALERT_EN register.

Table 15. Status Byte Operations

| Bit | Name | Function |
|-----|------------|--|
| 0 | ADC_OC | An ADC-based overcurrent comparison is detected on the last three conversions. |
| 1 | ADC_ALERT | An ADC-based overcurrent trip has occurred, causing the alert. Cleared by writing to Bit 4 of the ALERT_EN register. |
| 2 | OC | An overcurrent condition is present (that is, the output of the current sense amplifier is greater than the voltage on the SETV input). |
| 3 | OC_ALERT | An overcurrent condition causes the ALERT block to latch a fault, and the ALERTB output asserts. Cleared by writing to Bit 4 of the ALERT_EN register. |
| 4 | OFF_STATUS | Set to 1 by writing to the SWOFF bit of the CONTROL register. |
| 5 | OFF_ALERT | An alert has been caused by the SWOFF bit. Cleared by writing to Bit 4 of the ALERT_EN register. |

APPLICATIONS INFORMATION

ALERTB OUTPUT

The ALERTB output is an open-drain pin with 30 V tolerance. This output can be used as an overcurrent flag by connecting it to the general-purpose logic input of a controller. During normal operation, this output is pulled high (an external pull-up resistor should be used because this is an open-drain pin). When an overcurrent condition occurs, the ADM1191 pulls this output low. The ALERTB pin is disabled by default on power up. See the ALERT_EN register to enable.

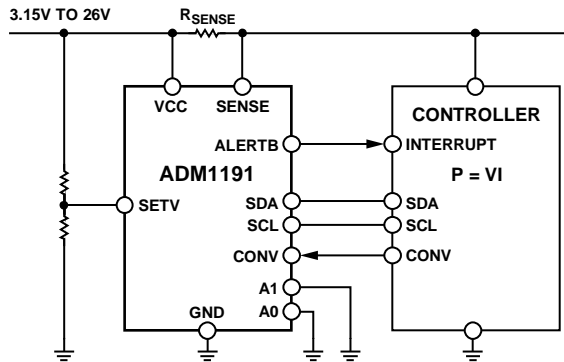


Figure 25. Using the ALERTB Output as an Interrupt

SETV PIN

The SETV pin allows the user to adjust the current level that trips the ALERTB output. The output of the current sense amplifier is compared with the voltage driven onto the SETV pin. If the current sense amplifier output is higher than the SETV voltage, the output of the comparator asserts. By driving a different voltage onto the SETV pin, the ADM1191 detects an overcurrent

condition at a different current level, with a gain of 18. See Figure 12 for an illustration of this relationship.

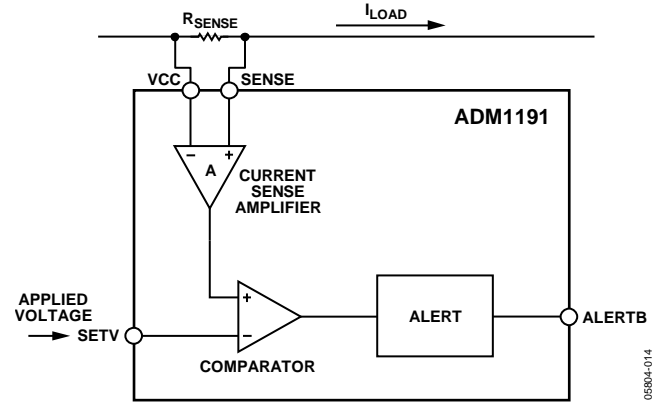
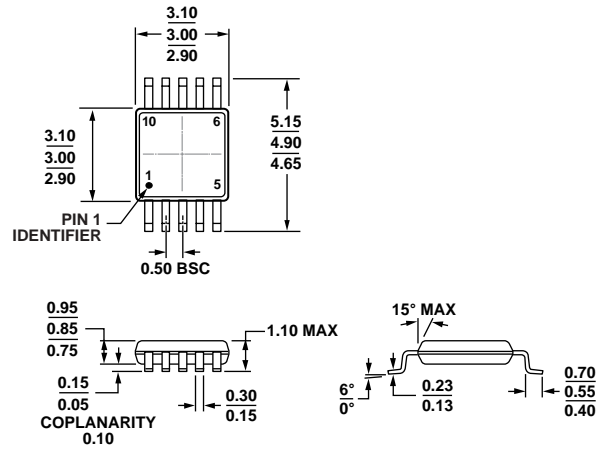


Figure 26. SETV Operation

KELVIN SENSE RESISTOR CONNECTION

When using a low value sense resistor for high current measurement, the problem of parasitic series resistance can arise. The pad and solder resistance can be a substantial fraction of the rated resistance, making the total resistance larger than expected. This error problem can be largely avoided by using a Kelvin sense connection. This type of connection separates the high current path through the resistor and the voltage drop across the resistor. A 4-pad resistor may be used or a split pad layout can be used with a 2-pad sense resistor to achieve Kelvin sensing.

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-187-BA

Figure 27. 10-Lead Mini Small Outline Package [MSOP] (RM-10)

Dimensions shown in millimeters

091709-A

ORDERING GUIDE

| Model ¹ | Temperature Range | Package Description | Package Option | Branding |
|--------------------|-------------------|---------------------|----------------|----------|
| ADM1191-2ARMZ-R7 | -40°C to +85°C | 10-Lead MSOP | RM-10 | M5L |
| EVAL-ADM1191EBZ | | Evaluation Board | | |

¹ Z = RoHS Compliant Part.

Purchase of licensed I²C components of Analog Devices, Inc., or one of its sublicensed Associated Companies conveys a license for the purchaser under the Philips I²C Patent Rights to use these components in an I²C system, provided that the system conforms to the I²C Standard Specification as defined by Philips.